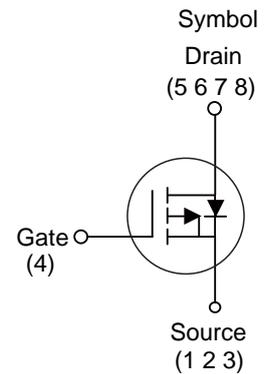


**PRODUCT CHARACTERISTICS**

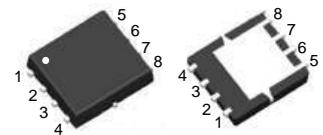
$V_{DSS}$	-100V
$R_{DS(ON)}$ Typ(@ $V_{GS}=-10V$ )	85m $\Omega$
$R_{DS(ON)}$ Typ(@ $V_{GS}=-4.5V$ )	95m $\Omega$
$I_D$	-18A


**APPLICATIONS**

- \* Electronic lamp ballasts based on half bridge
- \* Load Switching, Quick/Wireless Charge.
- \* Motor Driving

**FEATURE**

- \* Low Gate Charge
- \* Pb-Free Lead Plating



PDFN3X3

**ORDER INFORMATION**

Order Codes		Package	Packing
Halogen-Free	Halogen		
N/A	MOT1793J	PDFN3X3	5000 pieces/Reel

**ABSOLUTE MAXIMUM RATINGS**( $T_A=25^{\circ}C$ , unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	$V_{DSS}$	-100	V
Gate-Source Voltage	$V_{GSS}$	$\pm 20$	V
Drain Current Continuous(@ $V_{GS}=10V, T_A=25^{\circ}C$ )	$I_D$	-18	A
Drain Current Pulsed	$I_{DM}$	-72	A
Avalanche Energy	$E_{AS}$	144	mJ
Power Dissipation	$P_D$	70	W
Junction Temperature	$T_J$	+150	$^{\circ}C$
Storage Temperature	$T_{STG}$	-55~ +150	$^{\circ}C$

**THERMAL CHARACTERISTICS**

Parameter	Symbol	Typ	Unit
Junction to Case	$R_{thJC}$	1.79	$^{\circ}C/W$

**■ ELECTRICAL CHARACTERISTICS** ( $T_C=25^\circ\text{C}$ , unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain to Source Breakdown Voltage	$V_{DS}$	$V_{GS}=0V, I_D=-250\mu A$	-100	-	-	V
Drain to Source Leakage Current	$I_{DSS}$	$V_{DS}=-100V, V_{GS}=0V$	-	-	-1	$\mu A$
Gate to Source Forward Leakage	$I_{GSS(F)}$	$V_{GS}=+20V, V_{DS}=0V$	-	-	100	nA
Gate to Source Reverse Leakage	$I_{GSS(R)}$	$V_{GS}=-20V, V_{DS}=0V$	-	-	-100	nA
On characteristics						
Drain to Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-9A$	-	85	95	m $\Omega$
		$V_{GS}=-4.5V, I_D=-9A$	-	95	110	m $\Omega$
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1	-1.7	-2.5	V
Dynamic characteristics						
Gate capacitance	$R_g$	$V_{GS}=0V, V_{DS}=0V, f=1.0\text{MHz}$	-	5.4	-	$\Omega$
Forward Transconductance	$g_{fs}$	$V_{DS}=-5V, I_D=-3A$	-	14	-	S
Input Capacitance	$C_{iss}$	$V_{DS}=-25V, V_{GS}=0V$ $f=1.0\text{MHz}$	-	3810	-	pF
Output Capacitance	$C_{oss}$		-	108	-	pF
Reverse Transfer Capacitance	$C_{rss}$		-	192	-	pF
Resistive Switching Characteristics						
Turn-on Delay Time	$t_{d(ON)}$	$V_{GS}=-10V, V_{DS}=-50V,$ $I_D=-16A, R_G=9.1\Omega$	-	16	-	ns
Rise Time	$t_r$		-	73	-	ns
Turn-off Delay Time	$t_{d(OFF)}$		-	34	-	ns
Fall Time	$t_f$		-	57	-	ns
Total Gate Charge	$Q_g$	$I_D=-16A, V_{DS}=-50V$ $V_{GS}=-10V$	-	61	-	nC
Gate to Source Charge	$Q_{gs}$		-	14	-	nC
Gate to Drain("Miller") Charge	$Q_{gd}$		-	29	-	nC
Source-Drain Diode Characteristics						
Continuous Source Current(Body Diode)	$I_S$		-	-	-18	A
Maximum Pulsed Current(Body Diode)	$I_{SM}$		-	-	-72	A
Diode Forward Voltage	$V_{SD}$	$I_{SD}=-1A, V_{GS}=0V$	-	-0.8	-1.2	V
Reverse Recovery Time	$t_{rr}$	$I_{SD}=-16A, T_J=25^\circ\text{C}$ $di/dt=100A/\mu s$	-	88.3	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	65.9	-	nC

TYPICAL CHARACTERISTICS

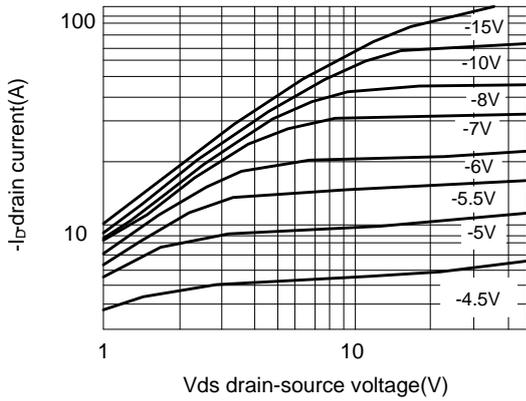


Figure 1: Output characteristics

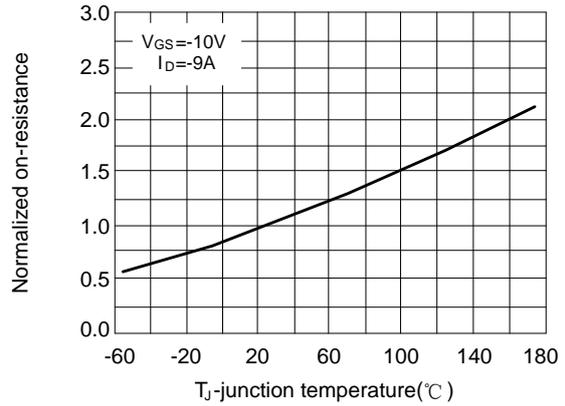


Figure 2: R<sub>ds(on)</sub>-junction temperature

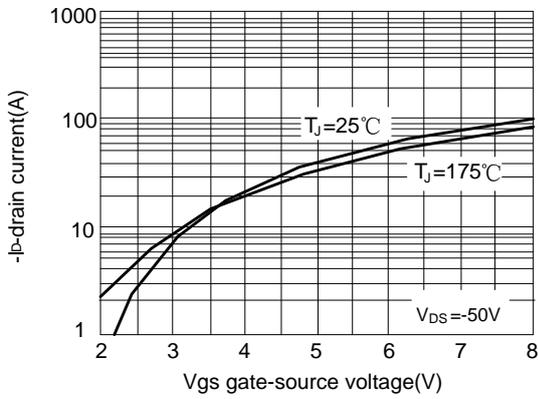


Figure 3: Transfer characteristics

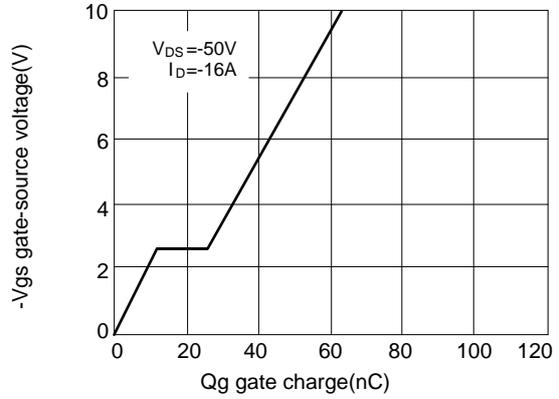


Figure 4: Gate charge

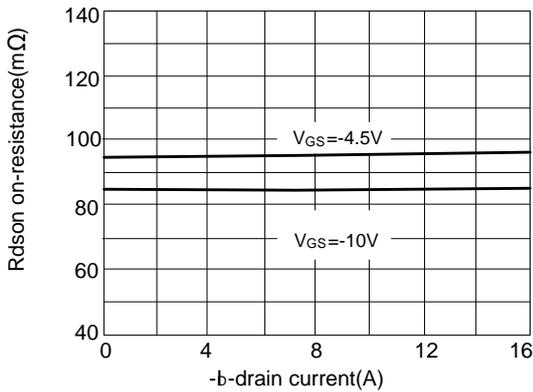


Figure 5: R<sub>ds(on)</sub>-drain current

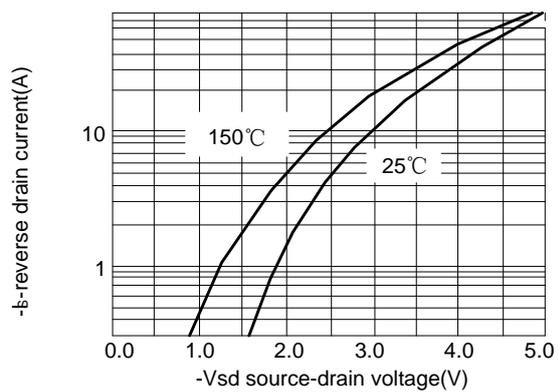


Figure 6: Source-drain diode forward

■ TYPICAL CHARACTERISTICS(Cont.)

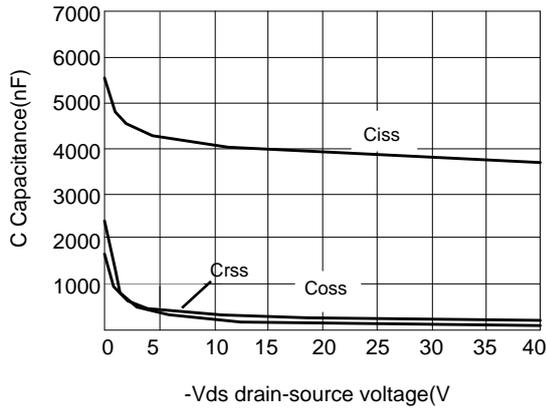


Figure 7: Capacitance vs vds

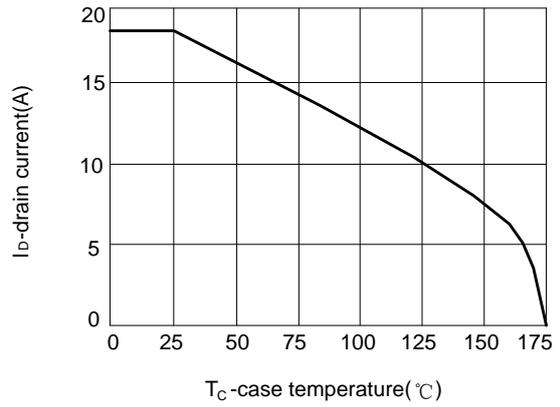


Figure 8: Drain current vs case temperature

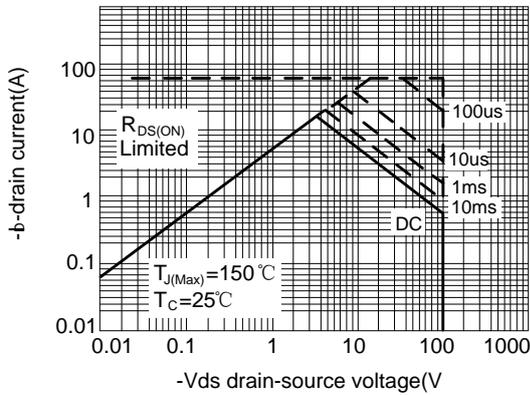


Figure 9: Safe operation area

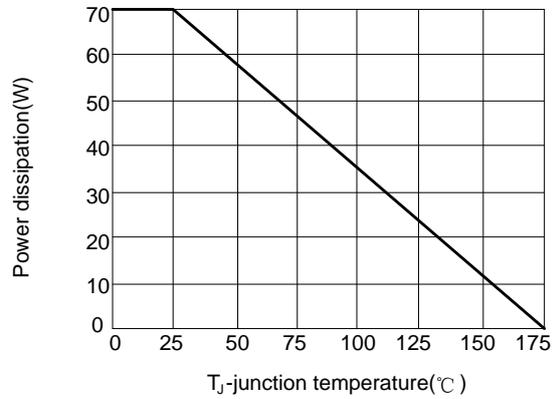
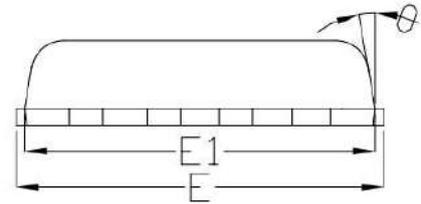
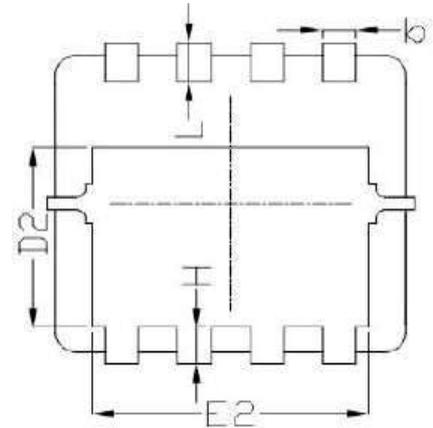
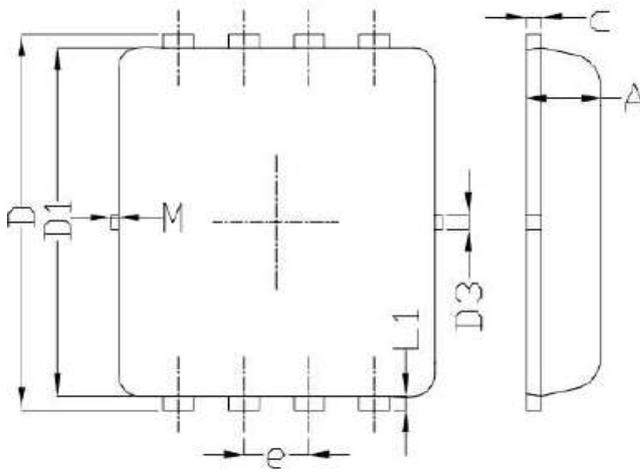
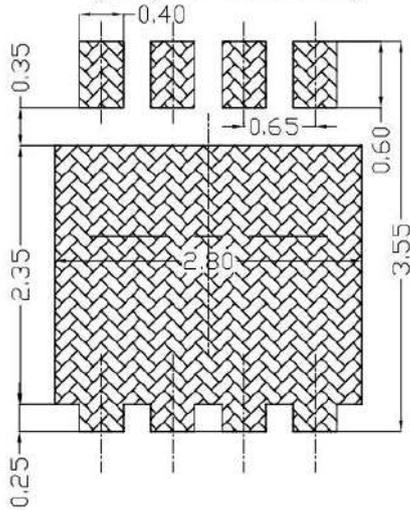


Figure 10: Powerde-rating

■ PDFN3X3 Package Mechanical Data



Land Pattern  
(Only for Reference)



SYMBOL	DIMENSIONAL REQMTS		
	MIN	NOM	MAX
A	0.70	0.75	0.80
b	0.25	0.30	0.35
c	0.10	0.15	0.25
D	3.25	3.35	3.45
D1	3.00	3.10	3.20
D2	1.78	1.88	1.98
D3	---	0.13	---
E	3.20	3.30	3.40
E1	3.00	3.15	3.20
E2	2.39	2.49	2.59
e	0.65BSC		
H	0.30	0.39	0.50
L	0.30	0.40	0.50
L1	---	0.13	---
$\theta$	---	10°	12°
M	*	*	0.15
* Not specified			